ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES INTERNATION CONNECTING	IPC, Bannock	burn, Illinois. A	Il rights reserved untions.	under both	This docum level parts, t	ent is a declara	ation of the sencompass	substances es all lowe	within the ma er level materia	nufacture als for whi	r listed item. ich the manut	Note: if	the item is an as has engineering	sembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard For http://www.ipc.org/IPC-175x Dis				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				s Material	ials and Mfg Information				
Supplier Information														
Company name*			Company unique ID			Unique ID Authority					Response Date*			
onsemi											2025-05-13			
Contact Name Title - Con			e - Contact			Phone - Contact*					Email - Contact*			
Product-Env-Stewards Produc			Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Represe			sentative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product E			oduct Enviro Compliance			NA					Product-Env-Stewards@onsemi.com			
Requester Item Number			Number Mfr Item Name			Effective Da	ve Date Version Manufacturing Site		Site	Weig	;ht*	UOM	Unit Type	
	NCP303 G	CP303151AMNTW 50A IMON Pow		er Stage DRMOS		2025-05-13			MY5		86.56	533	mg	Each
Aanufacturing Proccess Inform	ation													
Terminal Plating / Grid Array	Aaterial Terminal Base A		Alloy	y J-STD-020 MSL Rati		Peak Pro	Process Body Temperature Max Time at Peal		at Peak T	Temperature Number of Reflow Cycles			les	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30		seconds	3		
omments														
vel 1 - maximum time at peak tempera	ture during so	ldering is 10-3	0 seconds											
or more information regarding materi	al composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	6.8004	mg	Supplier	Zinc (Zn)	7440-66-6		0.0082	mg
			Supplier	Iron (Fe)	7439-89-6		0.1598	mg
			Supplier	Copper (Cu)	7440-50-8		6.6304	mg
			Supplier	Phosphorus (P)	7723-14-0		0.002	mg
Clip Attach	0.3	mg	Supplier	Silver (Ag)	7440-22-4		0.0075	mg
			А	Lead (Pb)	7439-92-1		0.2775	mg
			Supplier	Tin (Sn)	7440-31-5		0.015	mg
Die	2.7629	mg	Supplier	Silicon (Si)	7440-21-3		2.7629	mg
Ероху	4.401	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		0.3961	mg
			Supplier	Proprietary	Proprietary Data		0.0242	mg
			Supplier	Bismaleimide	13676-54-5		2.2203	mg
			Supplier	PTFE	9002-84-0		1.7604	mg
Lead Frame	32.9996	mg	Supplier	Zinc (Zn)	7440-66-6		0.0396	mg
			Supplier	Iron (Fe)	7439-89-6		0.7755	mg
			Supplier	Copper (Cu)	7440-50-8		32.1746	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0099	mg
Mold Compound-Black	36.0995	mg		Epoxy resin	proprietary data		4.8012	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0722	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		31.2261	mg
Plating	2.9998	mg	Supplier	Tin (Sn)	7440-31-5		2.9998	mg
Wire Bond - Cu	0.2001	mg	Supplier	Palladium (Pd)	7440-05-3		0.0036	mg
			Supplier	Gold (Au)	7440-57-5		0.0002	mg
			Supplier	Copper (Cu)	7440-50-8		0.1963	mg